WIRE FUSING

Adrian Bevan <u>a.j.bevan@qmul.ac.uk</u>



PREECE EQN

 1884: Preece* considered balancing heat generation from I²R with heat loss as πhdl for a wire element of length dl with heat loss per unit area (from radiation) of h.

$$I_f = \frac{\pi}{2} (\sigma h)^{1/2} d^{3/2}$$

- I_f = fuse current σ = electrical conductivity d = diameter of wire
- Complemented by the other limit, where heat loss is not relevant (e.g. instantaneous pulse without radiative losses).

$$I_b = d^2 \frac{\pi}{4} \sqrt{\frac{\int \rho C_p dt}{\int dt / \sigma}} \quad \begin{array}{ll} \mathsf{I}_{\mathsf{b}} = \mathsf{burst} \ (\mathsf{melt/vaporisation}) \ \mathsf{current} \\ \mathbf{\rho} = \mathsf{density} \ \mathsf{of} \ \mathsf{material} \\ \mathsf{C}_{\mathsf{p}} = \mathsf{specific} \ \mathsf{heat} \ (\mathsf{incl. latent} \ \mathsf{heat}) \end{array}$$

- Preece's argument relied on data to determine fusing currents for some fixed length, and so this argument does not hold for short bonds - should work for long enough wires where heat loss dominates.
- Assumes that the wire is in free air so that's also not the case if we pot bonds or bond heels.

*Preece, Royal Soc. Lon. 36, 464 (1884); ibid 43 280 (1887)

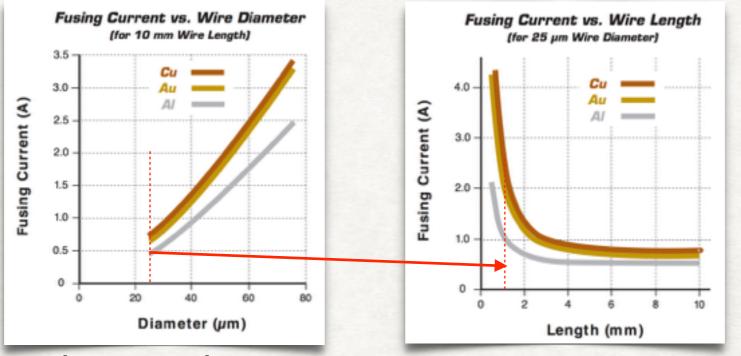
MODIFIED PREECE EQN

- Can take Preece and replace the constant of proportionality with some different value to account for the situation (MIL-SPEC uses epoxy packaging corrections; so corrections would be required for potted bonds or potted heels).
 - Does not apply to wires longer than 1mm
 - Does not have a material dependence
 - ... not very useful.
- Other models exist*; again these have assumptions; Stephan dug out the Power Systems Design article in his e-mails; Chen et al. go into more details, but these are still linear modes.
- Ultimately model based estimation may not be a good way to understand fuse and burst current limits for our use case.

*K. Chen et al., Prog Elec. Res. 31, 199-214 (2013); J. Shah, Power Systems Design Jul/Aug 2012

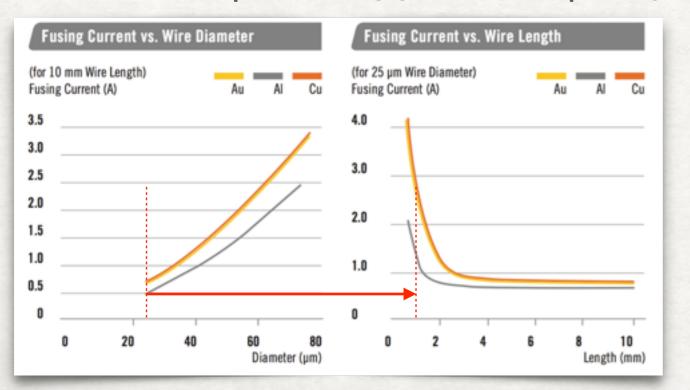
SUPPLIER SPECS

K&S specs: ~400 mA for a 25µm bond (1mm length).



WARNIG: Slight incompatibility (factor of 2) between LHS and RHS plots...

Heraeus specs: bigger discrepancy apparent



WARNIG: Slight incompatibility (factor of 2) between LHS and RHS plots...

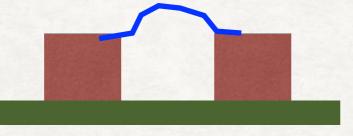
I don't trust the integrity of these results given that I can't understand the mis-match. Are they just Marketing plots?

WIRE CURRENT LIMITS ASSUMED

- Strips:
 - Ashley assumes an 800mA fuse current (including a naively assumed [i.e. guessed] factor of 2 for TID bump).
- Wire: 25µm x 250µm ribbon has a fuse current of ~3.5A for a 2mm length according to Accelonix.
 - 4 bonds "should" cover 9A (modulo reduction in fuse current from increased length with some overhead.

WHAT ARE OUR FUSE CURRENTS REALLY?

- There is a lot of physics that goes into fuse currents and it is clear that the literature has differences of opinion, and the manufacturers provide inconsistent results in their catalogues.
- I think this merits a quick bench test to understand our safety factors.
- Setting up a simple jig to bond out and fuse wire on to see how accurate plots are from Heraeus and K&S.

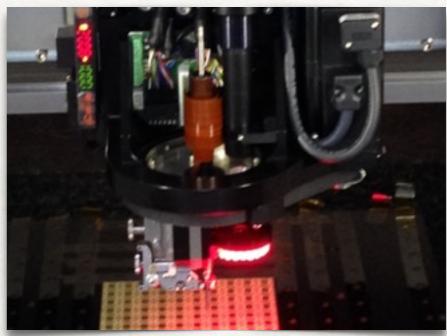


• Can re-work jig for different lengths (and ribbon tests).

WHAT DOES A DEEP ACCESS HEAD LOOK LIKE?

• The QM BJ820...

 DA head is setup in this picture for 25µm Al wire.



- Quickly reconfigurable to ribbon:
 - Requires a spool change, ribbon guide change, tool change and a modification to the wire feed loop gap.
 - Something that is straightforward to do.
 - Can also test ribbon fuse current if we buy ribbon and bond tools.